## SQJ180EP

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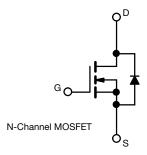
# Automotive N-Channel 80 V (D-S) 175 °C MOSFET



PRODUCT SUMMARY			
V <sub>DS</sub> (V)	80		
$R_{DS(on)} (\Omega)$ at $V_{GS} = 10 V$	0.0030		
I <sub>D</sub> (A)	248		
Configuration	Single		
Package	PowerPAK SO-8L		

#### FEATURES

- TrenchFET<sup>®</sup> Gen IV power MOSFET
- AEC-Q101 qualified
- 100 % R<sub>q</sub> and UIS tested
- $\bullet~Q_{gd}/Q_{gs}~ratio~<~1~optimizes~switching~characteristics$
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>



<b>ABSOLUTE MAXIMUM RATINGS</b> ( $T_C = 25 \text{ °C}$ , unless otherwise noted)						
PARAMETER		SYMBOL	LIMIT	UNIT		
Drain-source voltage		V <sub>DS</sub>	80	v		
Gate-source voltage		V <sub>GS</sub>	± 20	v		
Continuous drain current	T <sub>C</sub> = 25 °C	I	248			
	T <sub>C</sub> = 125 °C	I <sub>D</sub>	143			
Continuous source current (diode conduction)		I <sub>S</sub>	248	A		
Pulsed drain current		I <sub>DM</sub>	420			
Single pulse avalanche current	L = 0.1 mH	I <sub>AS</sub>	42			
Single pulse avalanche energy		E <sub>AS</sub>	88	mJ		
Maximum power dissipation	T <sub>C</sub> = 25 °C	Р	500	w		
	T <sub>C</sub> = 125 °C	P <sub>D</sub>	166	vv		
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +175	°C		
Soldering recommendations (peak temperature) <sup>b</sup>			260			

THERMAL RESISTANCE RATINGS						
PARAMETER		SYMBOL	LIMIT	UNIT		
Junction-to-ambient	PCB mount <sup>a</sup>	R <sub>thJA</sub>	42	°C/W		
Junction-to-case (drain)		R <sub>thJC</sub>	0.3	0/10		

Notes

a. When mounted on 1" square PCB (FR4 material)

b. See solder profile (<u>www.vishay.com/doc?73257</u>). The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection

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PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static		•		•		•	
Drain-source breakdown voltage	V <sub>DS</sub>	$V_{GS} = 0, I_D = 250 \ \mu A$		80	-	-	v
Gate-source threshold voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$		2.7	3.5	v
Gate-source leakage	I <sub>GSS</sub>	V <sub>DS</sub> =	$V_{DS} = 0 V, V_{GS} = \pm 20 V$		-	± 100	nA
Zero gate voltage drain current		V <sub>GS</sub> = 0 V V <sub>DS</sub> = 80 V		-	-	10	
	I <sub>DSS</sub>	$V_{GS} = 0 V$	V <sub>DS</sub> = 80 V, T <sub>J</sub> = 125 °C	-	-	50	μA
		$V_{GS} = 0 V$	V <sub>DS</sub> = 80 V, T <sub>J</sub> = 175 °C	-	-	250	
On-state drain current <sup>a</sup>	I <sub>D(on)</sub>	$V_{GS} = 10 V$	$V_{DS} \ge 5 V$	30	-	-	А
Drain-source on-state resistance <sup>a</sup>		$V_{GS} = 10 V$	I <sub>D</sub> = 15 A	-	0.0025	0.0030	Ω
	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 15 A, T <sub>J</sub> = 125 °C	-	-	0.0059	
		$V_{GS} = 10 \text{ V}$	I <sub>D</sub> = 15 A, T <sub>J</sub> = 175 °C	-	-	0.0075	
Forward transconductance b	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 10 A		-	82	-	S
Dynamic <sup>b</sup>				•		•	
Input capacitance	C <sub>iss</sub>		V <sub>DS</sub> = 25 V, f = 1 MHz	-	4746	6645	pF
Output capacitance	C <sub>oss</sub>	$V_{GS} = 0 V$		-	814	1140	
Reverse transfer capacitance	C <sub>rss</sub>			-	51	72	
Total gate charge <sup>c</sup>	Qg			-	78	117	nC
Gate-source charge <sup>c</sup>	Q <sub>gs</sub>	$V_{GS} = 10 V$	$V_{DS} = 40 \text{ V}, I_{D} = 10 \text{ A}$	-	18	-	
Gate-drain charge <sup>c</sup>	Q <sub>gd</sub>			-	16	-	
Gate resistance	Rg	f = 1 MHz		0.5	1.0	1.50	Ω
Turn-on delay time <sup>c</sup>	t <sub>d(on)</sub>	$V_{DD} = 40 \text{ V}, \text{ R}_{\text{L}} = 4 \Omega$ $I_{\text{D}} \cong 10 \text{ A}, \text{ V}_{\text{GEN}} = 10 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$		-	16	20	ns
Rise time <sup>c</sup>	t <sub>r</sub>			-	10	15	
Turn-off delay time <sup>c</sup>	t <sub>d(off)</sub>			-	39	50	
Fall time <sup>c</sup>	t <sub>f</sub>			-	9	15	
Source-Drain Diode Ratings and Chara	acteristics <sup>b</sup>	·			-		
Pulsed current <sup>a</sup>	I <sub>SM</sub>			-	-	420	Α
Forward voltage	V <sub>SD</sub>	$I_F = 15 \text{ A}, V_{GS} = 0 \text{ V}$		-	-	1.1	V
Body diode reverse recovery time	t <sub>rr</sub>	I <sub>F</sub> = 10 A, di/dt = 100 A/μs		-	50	65	ns
Body diode reverse recovery charge	Q <sub>rr</sub>			-	71	95	nC
Reverse recovery fall time	t <sub>a</sub>			-	28	44	-
Reverse recovery rise time	t <sub>b</sub>			-	22	38	ns
Body diode peak reverse recovery current	I <sub>RM(REC)</sub>			-	2.4	3.6	А

#### Notes

a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %

b. Guaranteed by design, not subject to production testing

c. Independent of operating temperature

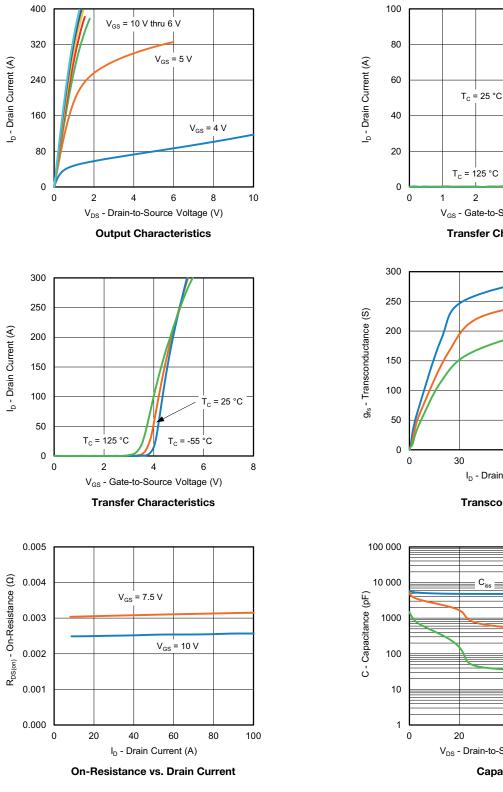
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

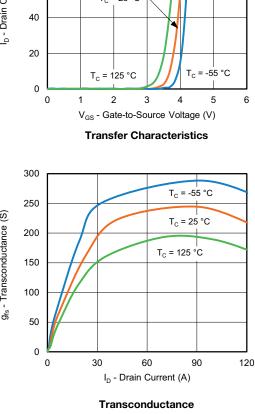
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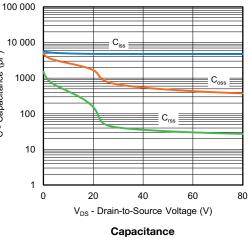


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### **TYPICAL CHARACTERISTICS** ( $T_A = 25 \text{ °C}$ , unless otherwise noted)







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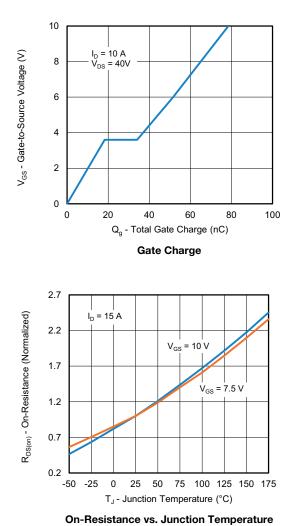
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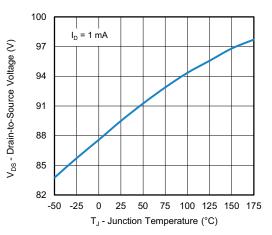


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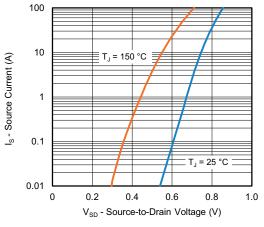
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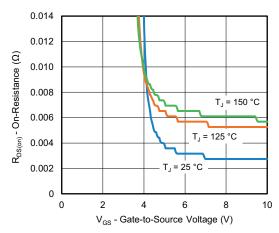




Drain Source Breakdown vs. Junction Temperature



Source Drain Diode Forward Voltage



On-Resistance vs. Gate-to Source Voltage

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 $I_D = 5 \text{ mA}$ 

100 125 150 175

 $I_D = 250 \ \mu A$ 

T<sub>.1</sub> - Junction Temperature (°C)

**Threshold Voltage** 

### **TYPICAL CHARACTERISTICS** (T<sub>A</sub> = 25 °C, unless otherwise noted)

0.5

0.1

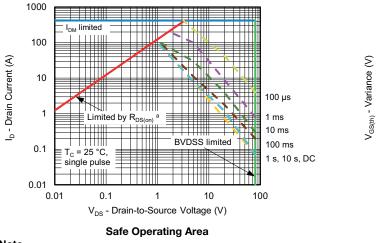
-0.3

-0.7

-1.1

-1.5

-50 -25 0 25 50 75



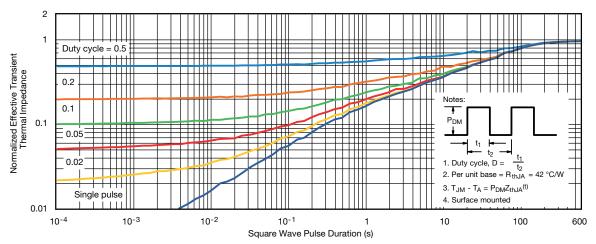


a.  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified

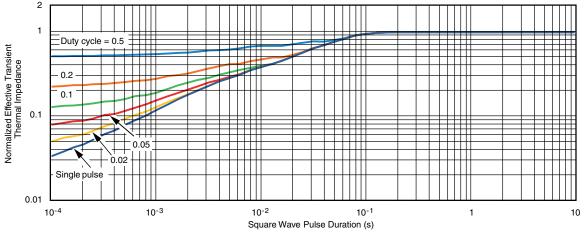


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#### **TYPICAL CHARACTERISTICS** ( $T_A = 25 \text{ °C}$ , unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

#### Note

• The characteristics shown in the two graphs

- Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)

- Normalized Transient Thermal Impedance Junction-to-Case (25 °C)

are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions

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